

September 2009

MOC8111M, MOC8112M, MOC8113M 6-Pin DIP Optocoupler for Power Supply Applications (No Base Connection)

Description

improved noise immunity.

The MOC811XM series consists of a Gallium Arsenide

IRED coupled with an NPN phototransistor. The base of the transistor is not bonded to an external pin for

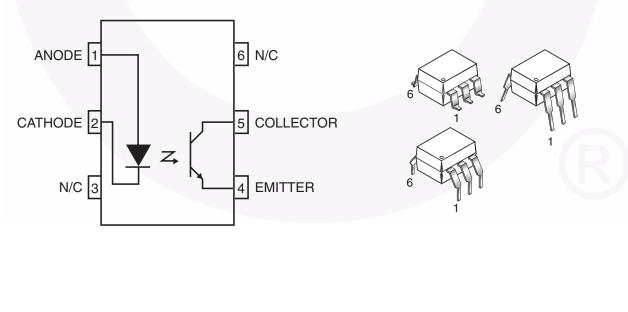
Features

- High isolation voltage 7500 VAC Peak—1 second
- High BV_{CEO} minimum 70 Volts
- Current transfer ratio in selected groups: MOC8111M: 20% min. MOC8112M: 50% min. MOC8113M: 100% min.
- Maximum switching time in saturation specified
- Underwriters Laboratory (UL) recognized (File #E90700, Vol. 2)
- IEC60747-5-2 approved (ordering option V)

Applications

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs
- Appliance sensor systems
- Industrial controls

Schematic



©2007 Fairchild Semiconductor Corporation MOC8111M, MOC8112M, MOC8113M Rev. 1.0.3

Absolute Maximum Ratings (T_A = 25°C Unless otherwise specified.) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Unit
TOTAL DEVIC	E		
PD	Total Device Power Dissipation @ T _A = 25°C	260	mW
	Derate above 25°C	3.5	mW/°C
T _{OPR}	Ambient Operating Temperature Range	-40 to +100	°C
T _{STG}	Storage Temperature Range	-40 to +150	°C
T _{SOL}	Lead Soldering Temperature (Wave Solder) (1/16" from case, 10 sec. duration)	260	°C
NPUT LED			-!
I _F	Forward Current – Continuous	90	mA
l _F (pk)	Forward Current – Peak (PW = 1µs, 300pps)	3	A
V _R	Reverse Voltage	6	V
PD	LED Power Dissipation @ T _A = 25°C	135	mW
	Derate above 25°C	1.8	mW/°C
OUTPUT TRA	NSISTOR		
PD	Detector Power Dissipation @ T _A = 25°C	200	mW
	Derate above 25°C	2.67	mW/°C

Electrical Characteristics ($T_A = 25^{\circ}C$ Unless otherwise specified.)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
EMITTER	1					
V _F	Input Forward Voltage	I _F = 60mA		1.35	1.65	V
		I _F = 10mA		1.15	1.50	1
V _R	Reverse Voltage	I _R = 10μΑ	6.0	15		V
CJ	Capacitance	V _F = 0V, f = 1.0MHz		50		pF
		V _F = 1V, f = 1.0MHz		65]
I _R	Reverse Leakage Current	V _R = 3.0V		.35	10	μA
DETECTO	R					
BV _{CEO}	Breakdow Voltage, Collector to Emitter	I _C = 1.0mA, I _F = 0	70			V
BV _{ECO}	Breakdow Voltage, Emitter to Collector	I _E = 100μA, I _F = 0	7			V
I _{CEO}	Leakage Current, Collector to Emitter	V _{CE} = 10V, I _F = 0		5	50	V
C _{CE}	Capacitance, Collector to Emitter	V _{CE} = 0 V, f = 1MHz		8		pF

Isolation Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Units
V _{ISO}	Input-Output Isolation Voltage	f = 60Hz, t = 1 sec.	7500			V _{AC(PK)}
C _{ISO}	Isolation Capacitance	V _{I-O} = 0, f = 1MHz		0.5		pF

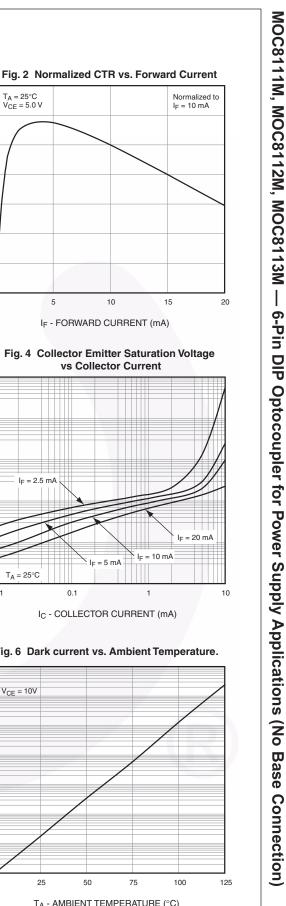
Transfer Characteristic

Symbol	Characteristics	Test Conditions	Device	Min.	Тур.	Max.	Units
DC CHAR	ACTERISTICS						
CTR	Output/Input Current	I _F = 10mA, V _{CE} = 5V	MOC8111M	20			%
	Transfer Ratio		MOC8112M	50			1
			MOC8113M	100			1
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	I _F = 10mA, I _C = 2.5mA	All		0.27	0.4	V
AC CHAR	ACTERISTICS						
Non-Satur	ated Switching Times						
t _{on}	Turn-On Time	$R_{L} = 100\Omega, I_{C} = 2mA,$	All		6.0	10	μs
t _{off}	Turn-Off Time	$V_{\rm CC}$ = 10V, See Figure 7	All		5.5	10	μs
Saturated	Switching Times						
t _{on}	Turn-On Time	I _F = 20mA, V _{CE} = 0.4V	MOC8111M		3.0	5.5	μs
		I _F = 10mA, V _{CE} = 0.4V	MOC812M/3M		4.2	8.0	
t _r	Rise-Time	I _F = 20mA, V _{CE} = 0.4V	MOC8111M		2.0	4.0	μs
		I _F = 10mA, V _{CE} = 0.4V	MOC812M/3M		3.0	6.0	1
t _{off}	Turn-Off Time	I _F = 20mA, V _{CE} = 0.4V	MOC8111M		18	34	μs
		I _F = 10mA, V _{CE} = 0.4V	MOC812M/3M		23	39	1
t _f	Fall-Time	I _F = 20mA, V _{CE} = 0.4V	MOC8111M		11	20	μs
		I _F = 10mA, V _{CE} = 0.4V	MOC812M/3M		14	24	1

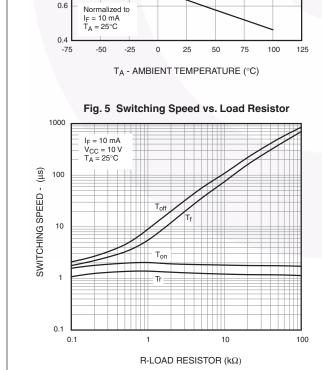
Safety and Insulation Ratings

As per IEC 60747-5-2, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Symbol	Parameter	Min.	Тур.	Max.	Unit
	Installation Classifications per DIN VDE 0110/1.89 Table 1				
	For Rated Main Voltage < 150Vrms		I-IV		
	For Rated Main voltage < 300Vrms		I-IV		
	Climatic Classification		55/100/21		
	Pollution Degree (DIN VDE 0110/1.89)		2		
CTI	Comparative Tracking Index	175			
V _{PR}	Input to Output Test Voltage, Method b, $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with tm = 1 sec, Partial Discharge < 5pC	1594			V _{peak}
	Input to Output Test Voltage, Method a, $V_{IORM} \times 1.5 = V_{PR}$, Type and Sample Test with tm = 60 sec, Partial Discharge < 5pC	1275			V _{peak}
VIORM	Max. Working Insulation Voltage	850			V _{peak}
V _{IOTM}	Highest Allowable Over Voltage	6000			V _{peak}
	External Creepage	7			mm
	External Clearance	7			mm
	Insulation Thickness	0.5			mm
RIO	Insulation Resistance at Ts, $V_{IO} = 500V$	10 ⁹			Ω



Typical Performance Characteristics Fig. 1 LED Forward Voltage vs. Forward Current 1.8 1.7 VF - FORWARD VOLTAGE (V) 1.6 NORMALIZED CTR 1.5 $T_A = -55^{\circ}C$ 1.4 1.3 1.2 T_A = 25°C 1.1 $T_A = 100^{\circ}C$ 1.0 10 100 1 IF - LED FORWARD CURRENT (mA) Fig. 3 Normalized CTR vs. Ambient Temperature V_{CE} (sat) - COLLECTOR-EMITTER SATURATION VOLTAGE (V) 1.6 1.4 $I_F = 5 \text{ mA}$ NORMALIZED CTR 1.2 $I_F = 10 \text{ mA}$ 1.0 0.8



I_F = 20 mA



10

vs Collector Current

IF - FORWARD CURRENT (mA)

15

l⊨ = 5 mA T_A = 25°C 0.001 0.01 0.1 1 IC - COLLECTOR CURRENT (mA)

1.4

1.2

1.0

0.8

0.6

0.4

0.2

0.0

100

10

1

0.1

0.0

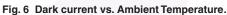
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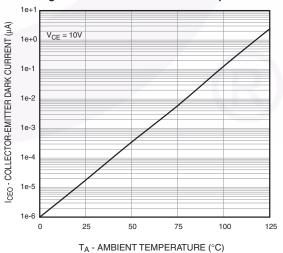
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I⊨ = 2.5 mA

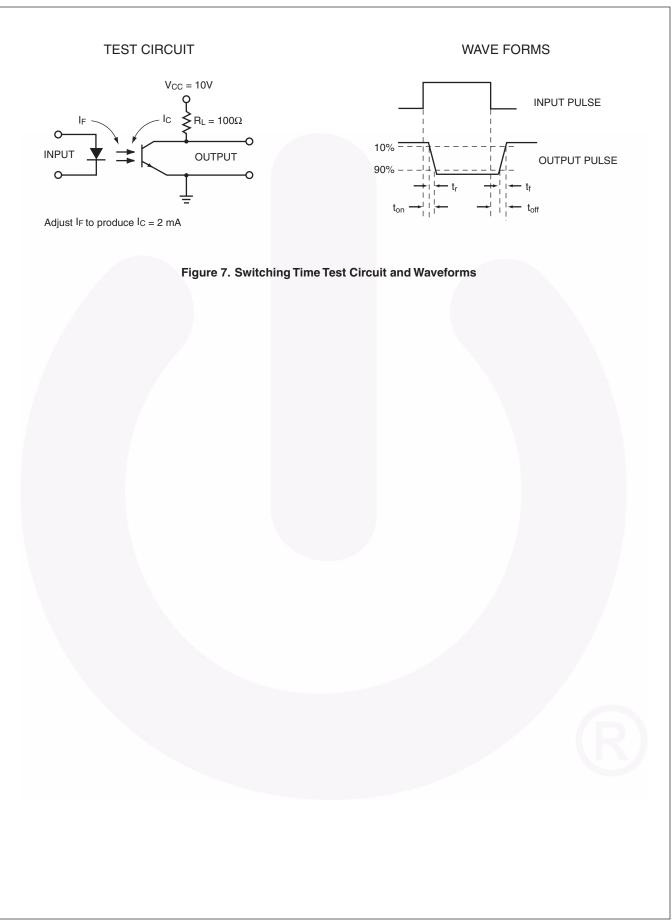
 $T_A = 25^{\circ}C$

V_{CE} = 5.0 V

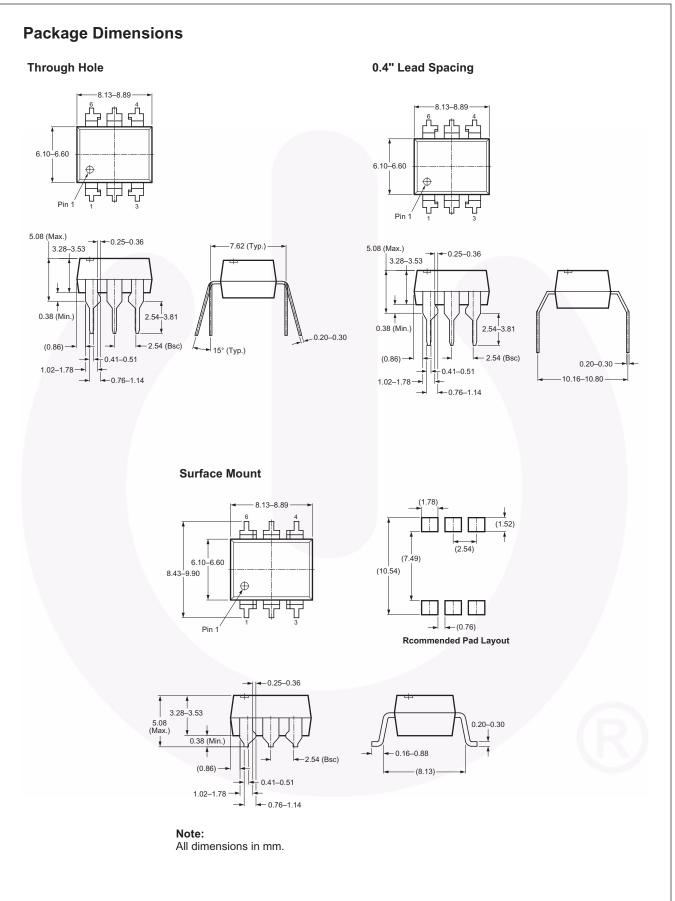




0.6



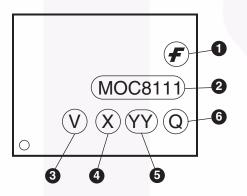
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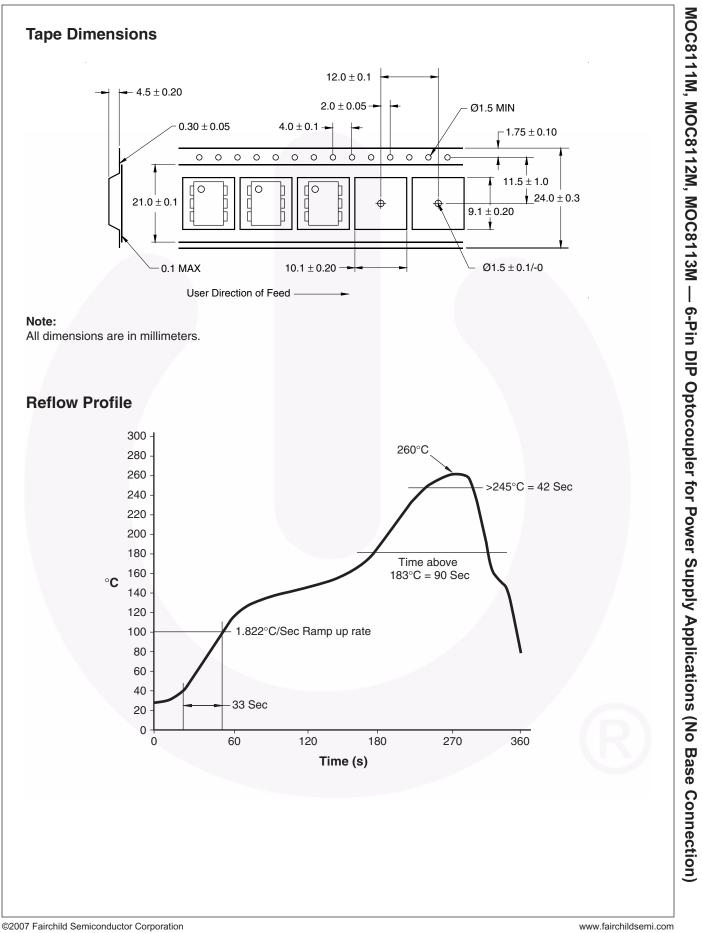
Ordering Information

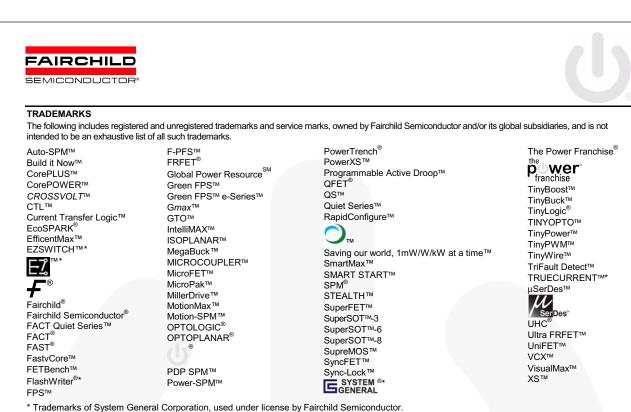
Option	Example Part Number	Description
No Suffix	MOC8111M	Through Hole
S	MOC8111SM	Surface Mount Lead Bend
SR2	MOC8111SR2M	Surface Mount; Tape and Reel
Т	MOC8111TM	0.4" Lead Spacing
V	MOC8111VM	VDE 0884
TV	MOC8111TVM	IEC60747-5-2 (VDE), 0.4" Lead Spacing
SV	MOC8111SVM	IEC60747-5-2 (VDE), Surface Mount
SR2V	MOC8111SR2VM	IEC60747-5-2 (VDE), Surface Mount, Tape and Reel

Marking Information



Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	One digit year code, e.g., '8'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			





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